

**Vishay Siliconix** 

## Dual P-Channel 20 V (D-S) MOSFET

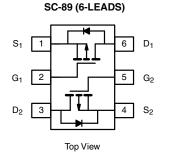
PRODU	CT SUMMARY		
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)
	0.756 at V <sub>GS</sub> = - 4.5 V	- 0.35	
- 20	1.038 at V <sub>GS</sub> = - 2.5 V	- 0.35	1 nC
- 20	1.44 at V <sub>GS</sub> = - 1.8 V	- 0.1	TINC
	2.4 at V <sub>GS</sub> = - 1.5 V	- 0.05	

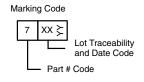
#### FEATURES

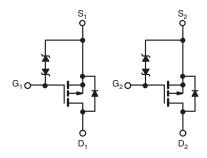
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Typical ESD protection: 1000 V (HBM)
- Fast Switching Speed
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Load and Small Signal Switch for Portable Devices
- Drivers: Relays, Solenoids, Displays, Lamps
- Battery Operated Systems
- Smart Phones, Tablet PCs







Ordering Information: Si1023CX-T1-GE3 (Lead (Pb)-free and Halogen-free)

Dual P-Channel MOSFET

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted) Symbol Parameter Limit Unit V<sub>DS</sub> - 20 **Drain-Source Voltage** v $V_{GS}$ Gate-Source Voltage ± 8 - 0.45<sup>b, c</sup> T<sub>A</sub> = 25 °C Continuous Drain Current (T<sub>1</sub> = 150 °C) $I_D$ T<sub>Δ</sub> = 70 °C - 0.36<sup>b, c</sup> А - 1.5 Pulsed Drain Current (t = $300 \mu s$ ) $I_{DM}$ T<sub>A</sub> = 25 °C Continuous Source-Drain Diode Current Is - 0.18<sup>b, c</sup> T<sub>A</sub> = 25 °C 0.22<sup>b, c</sup> Maximum Power Dissipation $P_D$ W T<sub>A</sub> = 70 °C 0.14<sup>b, c</sup> T<sub>J</sub>, T<sub>stg</sub> Operating Junction and Storage Temperature Range - 55 to 150 °C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 5 s		470	565	
Maximum Junction-to-Ambient <sup>a, b</sup>	Steady State State	R <sub>thJA</sub>	560	675	°C/W

Notes:

a. Maximum under steady state conditions is 675 °C/W.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

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Pb-free BoHS

## Si1023CX

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			<u> </u>	I	<u> </u>		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 1		- 12		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		1.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 0.4		- 1	V	
		$V_{DS} = 0 V$ , $V_{GS} = \pm 8 V$			± 30	- μΑ	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1		
		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 85 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ = $\geq$ 5 V, $V_{GS}$ = - 4.5 V	- 1.5			Α	
	( )	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 0.35 A		0.630	0.756		
	-	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 0.35 A		0.865	1.038		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.1 A		1.20	1.44	Ω	
		V <sub>GS</sub> = - 1.5 V, I <sub>D</sub> = - 0.05 A		1.6	2.4	_	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 0.4 A		1		S	
Dynamic <sup>b</sup>	-					1	
Input Capacitance	C <sub>iss</sub>			45			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		15		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			10			
		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 0.4 A		1.65	2.50	nC	
Total Gate Charge	Qg			1	2		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 10 V, $V_{GS}$ = - 2.5 V, $I_{D}$ = - 0.4 A		0.2			
Gate-Drain Charge	Q <sub>gd</sub>			0.26			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	2.4	12	24	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			9	18		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 33.3 $\Omega$		10	20		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D\cong$ - 0.3 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		10	20		
Fall Time	t <sub>f</sub>			8	16		
Turn-On Delay Time	t <sub>d(on)</sub>			1	2	ns -	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 33.3 $\Omega$		8	16		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -0.3 \text{ A}, V_{GEN} = -8 \text{ V}, \text{ R}_g = 1 \Omega$		9	18		
Fall Time	t <sub>f</sub>			5	10		
Drain-Source Body Diode Characterist	tics				•		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 1.5	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 0.3 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			16	24	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			8	16	nC	
Reverse Recovery Fall Time	ta	I <sub>F</sub> = - 0.3 A, dl/dt = 100 A/μs		11			
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

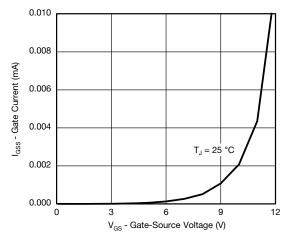
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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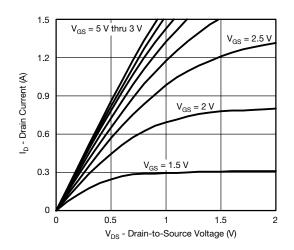
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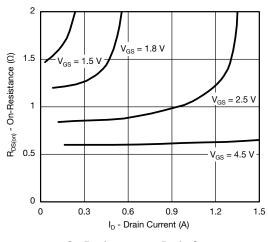
#### P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



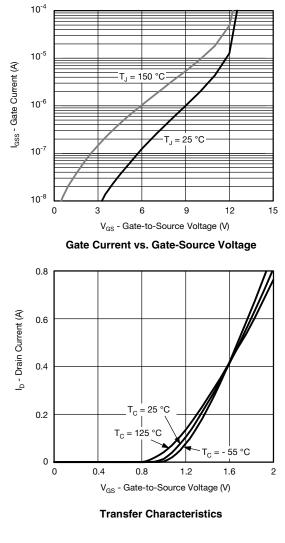
Gate Current vs. Gate-Source Voltage

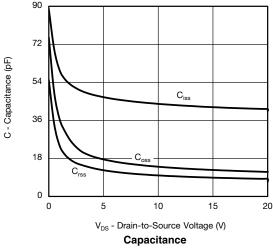






**On-Resistance vs. Drain Current** 





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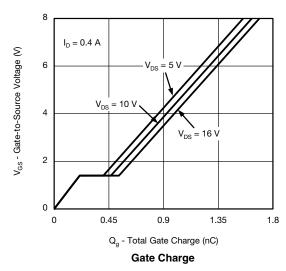
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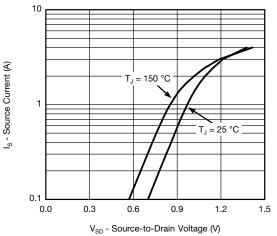
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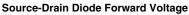


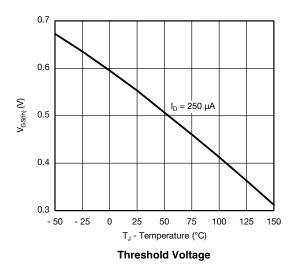
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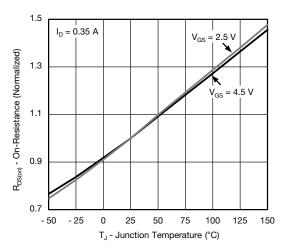
### P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



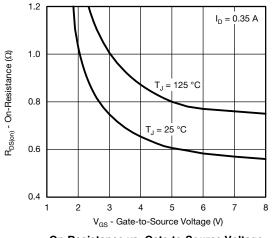




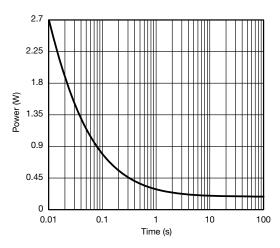




**On-Resistance vs. Junction Temperature** 







Single Pulse Power, Junction-to-Ambient

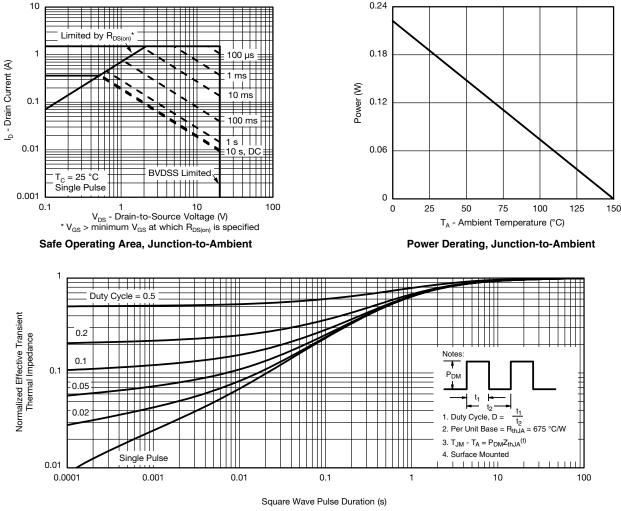
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## Si1023CX Vishay Siliconix

#### P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



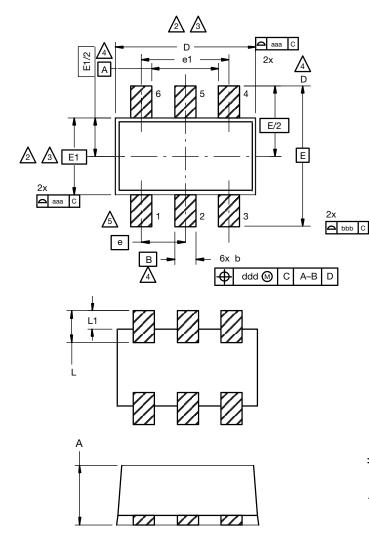
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63303.



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## SC-89 6-Leads (SOT-563F)



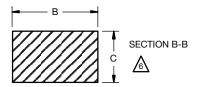
Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

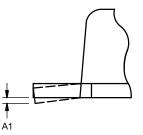
A Datums A, B and D to be determined 0.10 mm from the lead tip.

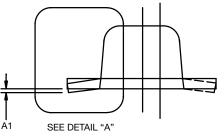
 $\triangle$  Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS			
	MIN.	NOM.	MAX.	
А	0.56	0.58	0.60	
A1	0	0.02	0.10	
b	0.15	0.22	0.30	
С	0.10	0.14	0.18	
D	1.50	1.60	1.70	
E	1.50	1.60	1.70	
E1	1.15	1.20	1.25	
е	0.45	0.50	0.55	
e1	0.95	1.00	1.05	
L	0.25	0.35	0.50	
L1	0.10	0.20	0.30	
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14			

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

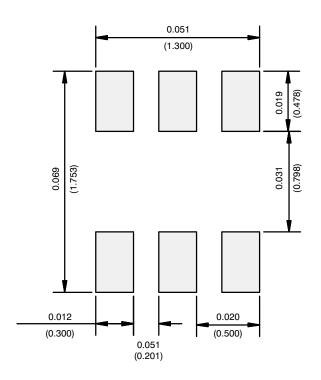
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# Application Note 826

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#### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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